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**PATENT NUMBER and
ISSUE DATE**

U.S. UTILITY Patent Application

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10033114	10/22/2001	438	22	2812	<i>Garcia</i>

****APPLICANTS:** Lee Tai-Peng; Jang Chuck;

****CONTINUING DATA VERIFIED:**

**** FOREIGN APPLICATIONS VERIFIED:**

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no Verified and Acknowledged Examiners's initials		ATTORNEY DOCKET NO M-11912 US
TITLE : Reduced thickness variation in a material layer deposited in narrow and wide integrated circuit trenches		

U.S. DEPT. OF COMM./PAT. & TM-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
ISSUE FEE Amount Due Date Paid		DRAWING Sheets Drwg. Figs.Drwg. Print Fig.	
<input type="checkbox"/> TERMINAL DISCLAIMER		Application Examiner	
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